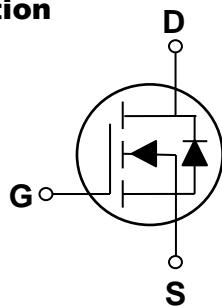
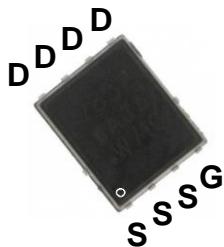


## General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## PPAK5X6 Pin Configuration



BVDSS	RDS(ON)	ID
100V	7.2mΩ	65A

## Features

- 100V,65A, RDS(ON) =7.2mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

## Applications

- Networking
- Load Switch
- LED applications
- Quick Charger



## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	+20 / -12	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ ) (Chip Limitation)	65	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ ) (Chip Limitation)	41.1	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	260	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	231	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	68	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	139	W
	Power Dissipation – Derate above 25°C	1.11	W/°C
$T_{STG}$	Storage Temperature Range	-50 to 150	°C
$T_J$	Operating Junction Temperature Range	-50 to 150	°C

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.9	°C/W



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### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

#### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\mu\text{A}$	100	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $\text{I}_D=1\text{mA}$	---	0.049	---	$\text{V}/^\circ\text{C}$
$\text{I}_{\text{DS}}$	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=100\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=80\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$\text{I}_{\text{GS}}$	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=+20\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	100	$\text{nA}$

#### On Characteristics

$\text{R}_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=18\text{A}$	---	6	7.2	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}$ , $\text{I}_D=10\text{A}$	---	8.8	11.2	$\text{m}\Omega$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$ , $\text{I}_D = 250\mu\text{A}$	1.2	1.7	2.5	V
$\Delta \text{V}_{\text{GS(th)}}$	$\text{V}_{\text{GS(th)}}$ Temperature Coefficient		---	-5.5	---	$\text{mV}/^\circ\text{C}$
$\text{gfs}$	Forward Transconductance	$\text{V}_{\text{DS}}=10\text{V}$ , $\text{I}_D=3\text{A}$	---	15	---	S

#### Dynamic and switching Characteristics

$\text{Q}_g$	Total Gate Charge <sup>3, 4</sup>	$\text{V}_{\text{DS}}=80\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=10\text{A}$	---	53.5	80	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge <sup>3, 4</sup>		---	7.5	12	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge <sup>3, 4</sup>		---	13.3	20	
$\text{T}_{\text{d(on)}}$	Turn-On Delay Time <sup>3, 4</sup>	$\text{V}_{\text{DD}}=50\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{R}_G=6\Omega$	---	14.6	30	ns
$\text{T}_r$	Rise Time <sup>3, 4</sup>		---	32.8	66	
$\text{T}_{\text{d(off)}}$	Turn-Off Delay Time <sup>3, 4</sup>		---	62.2	125	
$\text{T}_f$	Fall Time <sup>3, 4</sup>		---	28.4	56	
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{DS}}=25\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $\text{F}=1\text{MHz}$	---	3200	6400	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	873	1740	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	87	174	
$\text{R}_g$	Gate resistance	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$ , $\text{F}=1\text{MHz}$	---	1.25	---	$\Omega$

#### Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{I}_s$	Continuous Source Current	$\text{V}_G=\text{V}_D=0\text{V}$ , Force Current	---	---	65	A
$\text{I}_{\text{SM}}$	Pulsed Source Current		---	---	130	A
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

Note :

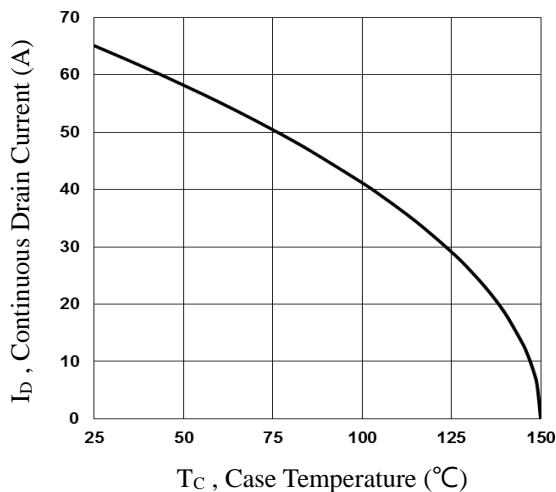
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $\text{V}_{\text{DD}}=50\text{V}$ ,  $\text{V}_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $\text{I}_{\text{AS}}=68\text{A}$ ,  $\text{R}_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.



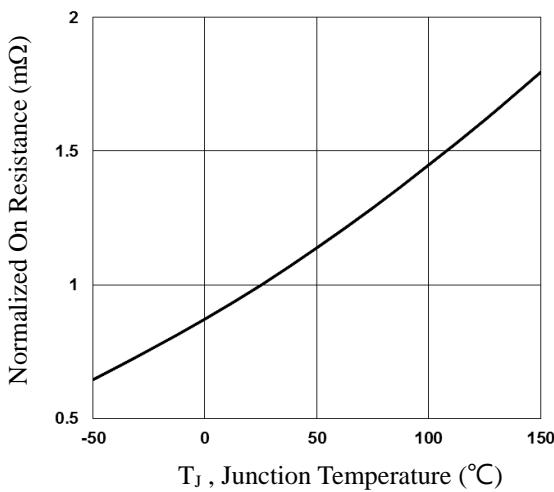
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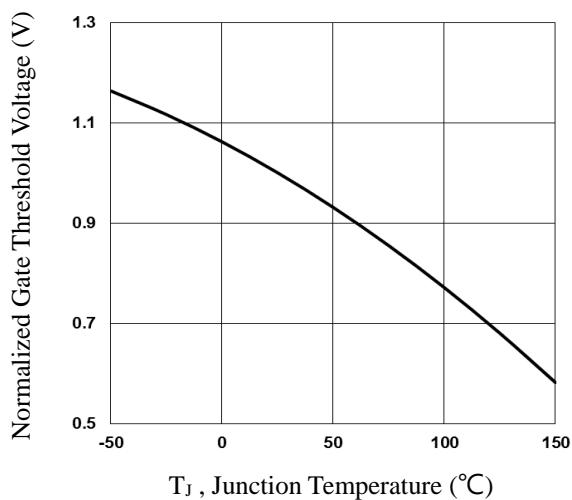
**SPC0978X**



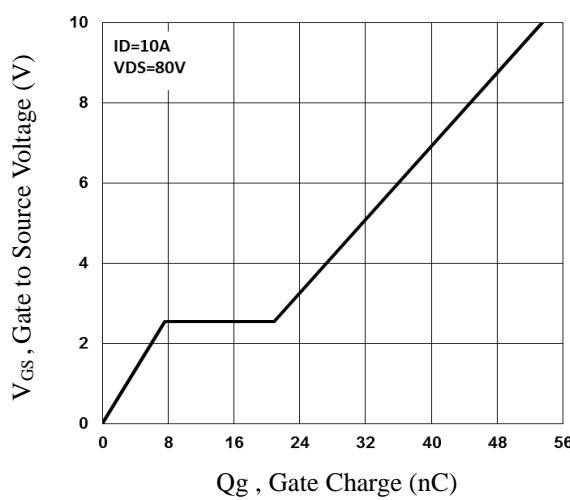
**Fig.1 Continuous Drain Current vs.  $T_C$**



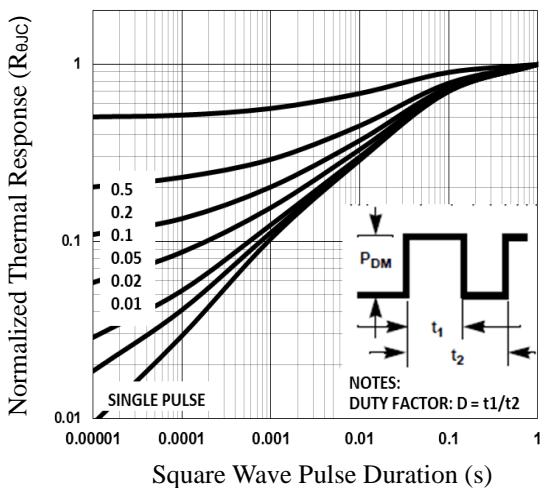
**Fig.2 Normalized RD<sub>SON</sub> vs.  $T_J$**



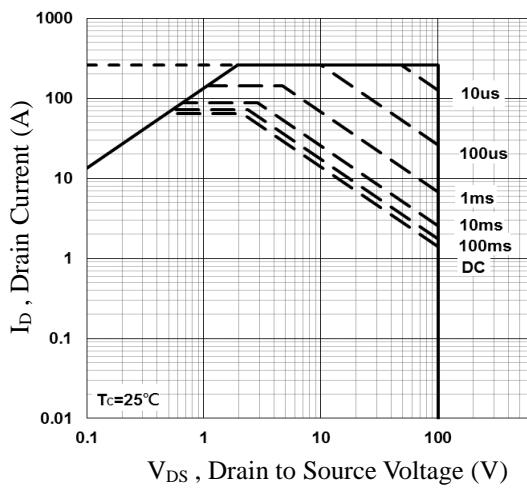
**Fig.3 Normalized V<sub>th</sub> vs.  $T_J$**



**Fig.4 Gate Charge Characteristics**



**Fig.5 Normalized Transient Impedance**



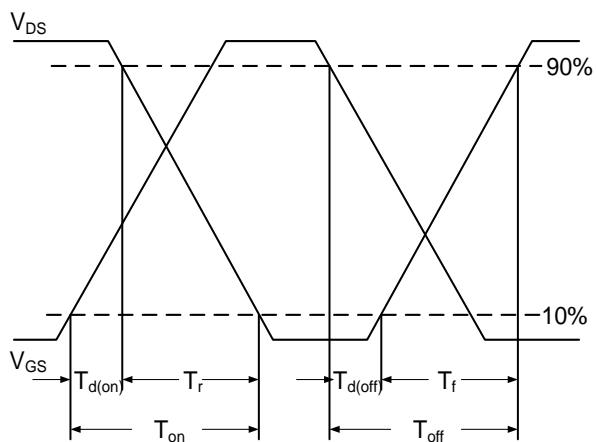
**Fig.6 Maximum Safe Operation Area**



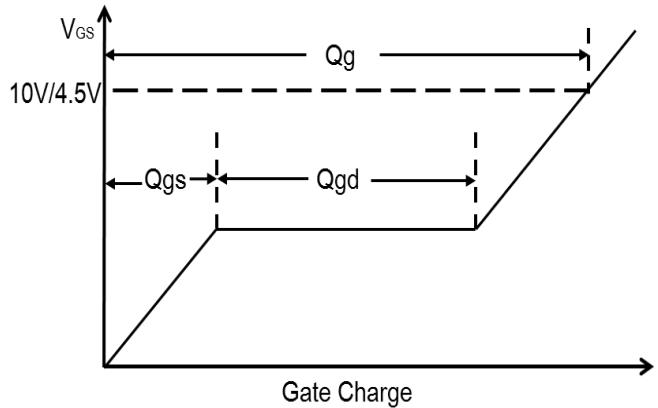
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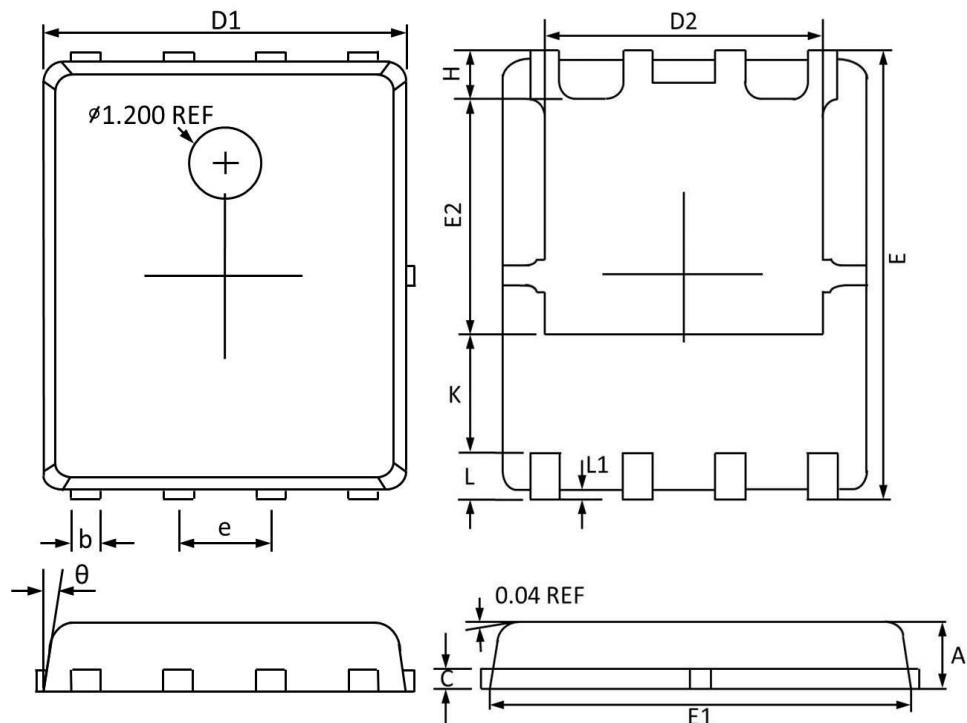
**Fig.7 Switching Time Waveform**



**Fig.8 Gate Charge Waveform**



## PPAK5X6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
θ	12°	0°	12°	0°